

Dual General Purpose Transistor NST3904DP6T5G

The NST3904DP6T5G device is a spin-off of our popular SOT-23/SOT-323/SOT-563 three-leaded device. It is designed for general purpose amplifier applications and is housed in the SOT-963 six-leaded surface mount package. By putting two discrete devices in one package, this device is ideal for low-power surface mount applications where board space is at a premium.

Features

- h_{FE}, 100-300
- Low $V_{CE(sat)}$, $\leq 0.4 \text{ V}$
- Reduces Board Space and Component Count
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant

MAXIMUM RATINGS

Rating		Symbol	Value	Unit
Collector - Emitter Voltage		V_{CEO}	40	Vdc
Collector - Base Voltage		V_{CBO}	60	Vdc
Emitter – Base Voltage		V _{EBO}	6.0	Vdc
Collector Current - Continuous		Ic	200	mAdc
Electrostatic Discharge	HBM MM	ESD Class	2 B	

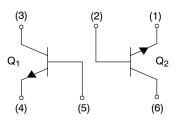
THERMAL CHARACTERISTICS

Characteristic (Single Heated)	Symbol	Max	Unit
Total Device Dissipation T _A = 25°C Derate above 25°C (Note 2)	P _D	240 1.9	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	520	°C/W
Total Device Dissipation T _A = 25°C Derate above 25°C (Note 3)	P _D	280 2.2	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 3)	$R_{\theta JA}$	446	°C/W
Characteristic (Dual Heated) (Note 4)	Symbol	Max	Unit
Total Device Dissipation T _A = 25°C Derate above 25°C (Note 2)	P _D	350 2.8	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	357	°C/W
Total Device Dissipation T _A = 25°C Derate above 25°C (Note 3)	P _D	420 3.4	mW mW/°C
	P _D		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- FR-4 @ 100 mm², 1 oz. copper traces, still air.
 FR-4 @ 500 mm², 1 oz. copper traces, still air.
- 4. Dual heated values assume total power is sum of two equally powered channels.

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NST3904DP6T5G



SOT-963 CASE 527AD

MARKING DIAGRAM



= Device Code = Date Code

ORDERING INFORMATION

Device	Package	Shipping [†]
NST3904DP6T5G	SOT-963 (Pb-Free)	8000 / Tape & Reel

DISCONTINUED (Note 1)

NSVT3904DP6T5G	SOT-963	8000 /
	(Pb-Free)	Tape & Reel

- †For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
- 1. DISCONTINUED: This device is not recommended for new design. Please contact your **onsemi** representative for information. The most current information on this device may be available on www.onsemi.com.

NST3904DP6T5G

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS		•		•	•
Collector - Emitter Breakdown Volta	age (Note 5) (I _C = 1.0 mAdc, I _B = 0)	V _{(BR)CEO}	40	-	Vdc
Collector - Base Breakdown Voltage	e (I _C = 10 μAdc, I _E = 0)	V _{(BR)CBO}	60	-	Vdc
Emitter - Base Breakdown Voltage	$(I_E = 10 \mu Adc, I_C = 0)$	V _{(BR)EBO}	6.0	-	Vdc
Collector Cutoff Current (V _{CE} = 30 \	Vdc, V _{EB} = 3.0 Vdc)	I _{CEX}	-	50	nAdc
ON CHARACTERISTICS (Note 5)		•		•	•
$\begin{array}{l} \text{DC Current Gain} \\ \text{(I}_{\text{C}} = 0.1 \text{ mAdc, V}_{\text{CE}} = 1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = 1.0 \text{ mAdc, V}_{\text{CE}} = 1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = 10 \text{ mAdc, V}_{\text{CE}} = 1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = 50 \text{ mAdc, V}_{\text{CE}} = 1.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = 100 \text{ mAdc, V}_{\text{CE}} = 1.0 \text{ Vdc)} \end{array}$		h _{FE}	40 70 100 60 30	- 300 - -	-
	ge	V _{CE(sat)}	- -	0.2 0.3	Vdc
$\begin{aligned} \text{Base-Emitter Saturation Voltage} \\ \text{(I}_{\text{C}} &= 10 \text{ mAdc, I}_{\text{B}} = 1.0 \text{ mAdc)} \\ \text{(I}_{\text{C}} &= 50 \text{ mAdc, I}_{\text{B}} = 5.0 \text{ mAdc)} \end{aligned}$		V _{BE(sat)}	0.65 -	0.85 0.95	Vdc
SMALL-SIGNAL CHARACTERIST	TICS		•	•	•
Current - Gain - Bandwidth Product	t (I _C = 10 mAdc, V _{CE} = 20 Vdc, f = 100 MHz)	f _T	200	-	MHz
Output Capacitance (V _{CB} = 5.0 Vdc, I _E = 0, f = 1.0 MHz)		C _{obo}	-	4.0	pF
Input Capacitance (V _{EB} = 0.5 Vdc, I _C = 0, f = 1.0 MHz)		C _{ibo}	-	8.0	pF
Noise Figure (V_{CE} = 5.0 Vdc, I_{C} = 100 μ Adc, R_{S} = 1.0 k Ω , f = 1.0 kHz)		NF	-	5.0	dB
SWITCHING CHARACTERISTICS					
Delay Time ($V_{CC} = 3.0 \text{ Vdc}, V_{BE} = -0.5 \text{ Vdc}$	t _d	_	35	
Rise Time ((I _C = 10 mAdc, I _{B1} = 1.0 mAdc)	t _r	-	35	ns
Storage Time ((V _{CC} = 3.0 Vdc, I _C = 10 mAdc)	t _s	-	275	
Fall Time ((I _{B1} = I _{B2} = 1.0 mAdc)	t _f	-	50	ns

^{5.} Pulse Test: Pulse Width ≤ 300 μs; Duty Cycle ≤ 2.0%.

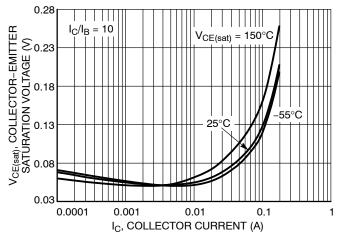


Figure 1. Collector Emitter Saturation Voltage vs.
Collector Current

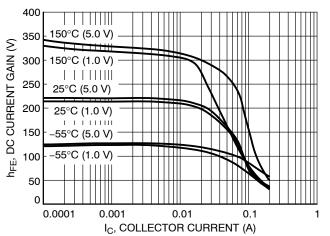


Figure 2. DC Current Gain vs. Collector Current

NST3904DP6T5G

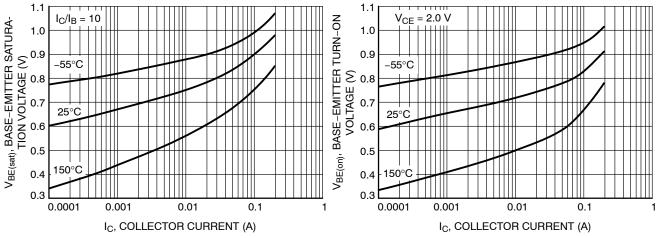


Figure 3. Base Emitter Saturation Voltage vs. Collector Current

Figure 4. Base Emitter Turn-On Voltage vs.
Collector Current

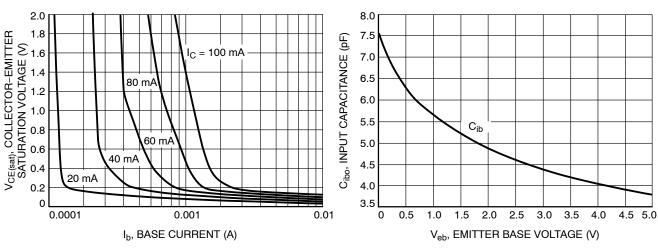


Figure 5. Saturation Region

Figure 6. Input Capacitance

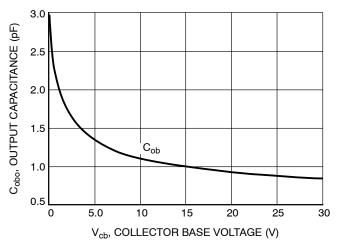


Figure 7. Output Capacitance





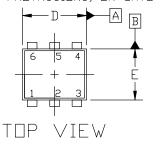
SOT-963 1.00x1.00x0.37, 0.35P CASE 527AD **ISSUE F**

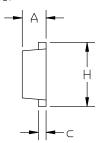
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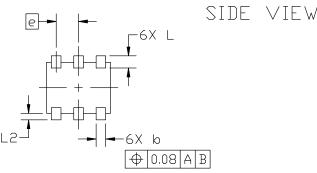
NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018. 1.
- CONTROLLING DIMENSION: MILLIMETERS.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

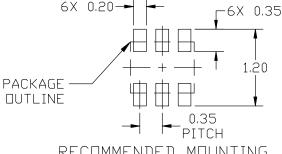
 DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH,
- PROTRUSIONS, OR GATE BURRS







MILLIMETERS DIM MIN. N□M. MAX. Α 0.34 0.37 0.40 0.10 0.15 0.20 h \subset 0.07 0.12 0.17 D 0.95 1.00 1.05 Ε 0.75 0.80 0.85 0.35 BSC 6 Н 1.00 0.95 1.05 0.19 REF L2 0.05 0.10 0.15



RECOMMENDED MOUNTING FOOTPRINT

*For additional information on our Pb-Free strategy and soldering details, please download the $\square N$ Semiconductor Soldering and Mounting Techniques Reference manual, SOLDERRM/D.

BUTTUM VIEW

STYLE 1: PIN 1. EMITTER 1 2. BASE 1 3. COLLECTOR 2 4. EMITTER 2 5. BASE 2 6. COLLECTOR 1	4. COLLECTOR 2 5. BASE 1	STYLE 3: PIN 1. CATHODE 1 2. CATHODE 1 3. ANODE/ANODE 2 4. CATHODE 2 5. CATHODE 2 6. ANODE/ANODE 1
STYLE 4: PIN 1. COLLECTOR 2. COLLECTOR 3. BASE 4. EMITTER	STYLE 5: PIN 1. CATHODE 2. CATHODE 3. ANODE 4. ANODE	STYLE 6: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE

TYLE 4:	STY
PIN 1. COLLECTOR	PI
2. COLLECTOR	
3. BASE	
4 CMITTED	

EMITTER 5 COLLECTOR 6. COLLECTOR

STYLE 7: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. ANODE 6. CATHODE STYLE 10: PIN 1. CATHODE 1 2. N/C 3. CATHODE 2

4. ANODE 2

6. ANODE 1

5. N/C

5. CATHODE 6. CATHODE STYLE 8: PIN 1. DRAIN 2. DRAIN 3. GATE 4. SOURCE 5. DRAIN 6. DRAIN

2. ANODE 3. CATHODE 4. CATHODE 5 CATHODE 6. CATHODE STYLE 9: PIN 1. SOURCE 1 2. GATE 1 3. DRAIN 2 4. SOURCE 2 5. GATE 2 6. DRAIN 1

GENERIC MARKING DIAGRAM*



XX = Specific Device Code = Month Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	SOT-963 1.00x1.00x0.37. 0).35P	PAGE 1 OF 1

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